

Interfacing the HI7190 to a Microcontroller

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Introduction

The Intersil HI7190 is a 24-bit monolithic instrumentation sigma delta A/D converter designed for applications such as Process Control and Measurement, Industrial Weigh Scales, Motion Control and Medical Equipment. The HI7190 serial I/O port is compatible with most synchronous transfer formats including the Motorola 6805/11 series SPI and Intel 8051 series SSR protocols. This application note discusses the HI7190 Serial Interface Port and details two application circuits useful in demonstrating how to interface the HI7190 to a microcontroller. For further information on this topic, see the HI7190 product datasheet and Technical Brief 331 "Using The HI7190 Serial Interface".

HI7190 Serial Port Signals

The HI7190 Sigma-Delta A/D converter communicates to a controlling device over either a 2 or 3-wire serial interface. Data is transmitted or received via a synchronous clock. The Serial Clock (SCLK) line is the synchronous data clock used to strobe the serial stream in or out of the HI7190 A/D converter. The data clock can be generated by the converter or can be supplied to the converter. When the HI7190 is the clock master, that mode is referred to as the Self Clocking mode. When the HI7190 is a clock slave, that mode is referred to as the External Clocking mode. The serial port also contains a status flag (Data Ready, DRDY) that signals a controller that the HI7190 has completed a conversion and the digital result is now available for reading from the device. The Data Ready flag is cleared by reading the HI7190's Data Register.

The HI7190 is selected, enabling an I/O operation, whenever the Chip Select (\overline{CS}) line is asserted low.

The HI7190 has 2 data lines that can be used with 2-wire or 3-wire serial bus interfaces. The Serial Data I/O (SDIO) line is a bidirectional data line that can be used as a dedicated input or a bidirectional data path. The Serial Data Out (SDO) line is a dedicated output pin for use in 3-wire interfaces where there must be a separate path for data in and data out. In a 2-wire interface, such as that used with Intel microcontrollers, the SDIO line is used exclusively for bidirectional data transfers. Figure 1 shows the pinout of the HI7190.

HI7190 Serial Protocol

When communicating with the HI7190 a set protocol must be followed. During the first phase of a transfer an instruction byte must be written to the device. The instruction byte contains the internal register address that will be accessed in the rest of the communication cycle. A typical communication cycle would involve an Instruction Cycle and a Data Cycle as shown in Figure 2. The data accessed during the Data Cycle is determined by the instruction byte contents.

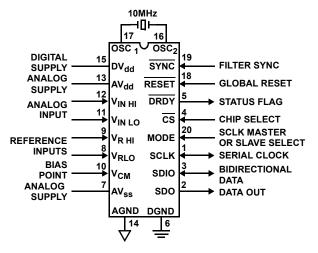


FIGURE 1. HI7190 SIGNAL DESCRIPTIONS

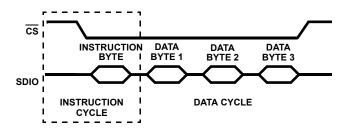
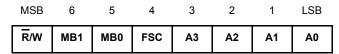


FIGURE 2. HI7190 COMMUNICATION CYCLE

The instruction byte allows access to the following registers internal to the HI7190.

- Control Register
- · Data Register
- · Zero Scale Calibration Register
- Positive Full Scale Calibration Register
- · Negative Full Scale Calibration Register

The instruction byte is organized as follows.



R/W - Bit 7 of the Instruction Register determines whether a read or write operation will be done following the instruction byte load. 0 = READ, 1 = WRITE.

MB1, **MB0** - Bits 6 & 5 of the Instruction Register determine the number of bytes that will be accessed following the instruction byte load. See Table 1 for the number of bytes to transfer in the Data Cycle.

TABLE 1. MULTIPLE BYTE ACCESS BITS

MB1	МВ0	DESCRIPTION
0	0	Transfer 1 Byte
0	1	Transfer 2 Bytes
1	0	Transfer 3 Bytes
1	1	Transfer 4 Bytes

FSC - Bit 4 is used to determine whether a Positive Full Scale Calibration Register I/O transfer (FSC = 0) or a Negative Full Scale Calibration Register I/O transfer (FSC = 1) is being performed (see Table 2).

A3, A2, A1, A0 - Bits 3 and 2 (A3 and A2) of the Instruction Register determine which internal register will be accessed while bits 1 and 0 (A1 and A0) determine which byte of that register will be accessed first. See Table 2 for the address decode.

TABLE 2. INTERNAL DATA ACCESS DECODE STARTING BYTE

FSC	А3	A2	A 1	A0	DESCRIPTION
Х	0	0	0	0	Data Output Register Byte 0
Х	0	0	0	1	Data Output Register Byte 1
Х	0	0	1	0	Data Output Register Byte 2
Х	0	1	0	0	Control Register Byte 0
Х	0	1	0	1	Control Register Byte 1
Х	0	1	1	0	Control Register Byte 2
Х	1	0	0	0	Offset Cal Register Byte 0
Х	1	0	0	1	Offset Cal Register Byte 1
Х	1	0	1	0	Offset Cal Register Byte 2
0	1	1	0	0	Positive Full Scale Cal Register Byte 0
0	1	1	0	1	Positive Full Scale Cal Register Byte 1
0	1	1	1	0	Positive Full Scale Cal Register Byte 2
1	1	1	0	0	Negative Full Scale Cal Register Byte 0
1	1	1	0	1	Negative Full Scale Cal Register Byte 1
1	1	1	1	0	Negative Full Scale Cal Register Byte 2

Interfacing to the 8X51 SSR Protocol

The HI7190 can interface to microcontrollers that use a 2 or 3-wire serial hardware interface. A 2-wire interface involves a tightly coupled system where a single converter is connected to a single microcontroller. In this mode only the serial clock line (SCLK) and the bidirectional data line (SDIO) are used to communicate between the A/D and the microcontroller. Figure 3 shows a 2-wire interface to an 8X51 style microcontroller.

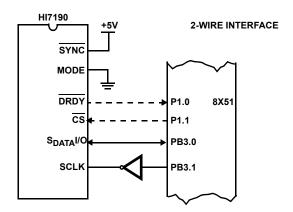


FIGURE 3. HI7190 INTERFACE TO 8X51

8051 Setup

Mode 0 of the 8X51 uses RXD (Port 3, Line 0) as the data port and TXD (Port 3, Line 1) as the shift clock. Data is shifted with LSB being the first bit in the sequence. The baud rate is fixed to 1/12 the microcontroller oscillator frequency. The 8X51 is the serial shift clock master therefor the HI7190 is placed in external clocking mode by grounding the MODE pin. The HI7190 can be set-up in polled mode where the status of the $\overline{\rm DRDY}$ line is read into the 8X51. When $\overline{\rm DRDY}$ is low, the HI7190 is ready to be accessed. In a multi-converter application the $\overline{\rm CS}$ line can be used to address each individual A/D in the system. In a single converter application the $\overline{\rm CS}$ may be grounded and an access is started by initiating the Instruction byte. The HI7190 should be reset to ensure proper power-up state. On power-up the HI7190 is configured for MSB first transfers and descending byte mode.

Since the 8X51 Intel microcontroller is a little endian designed machine, the HI7190 should be programmed for LSB first and ascending byte mode. Ascending byte mode will sequence through multiple bytes from least significant byte to most significant byte. The HI7190 expects data to be valid for the rising edge of the shift clock and shifts data out on falling edges. The 8X51 microcontroller is just the opposite. An inverter is needed on the serial clock line if the user wants to maintain approximately 1/2 clock cycle setup and hold times at the HI7190. Eliminating the inverter would give approximately a full clock cycle of setup time and zero hold time. The HI7190 will work in either design. Figure 4 shows the HI7190 port timing.

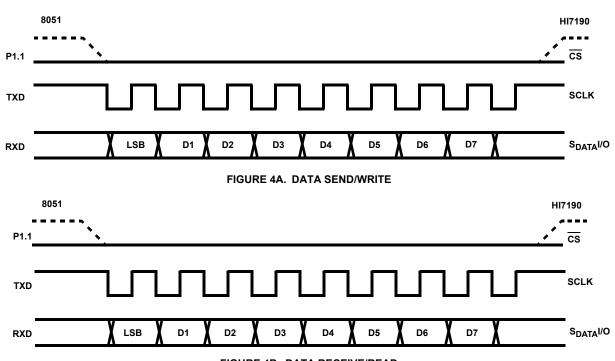


FIGURE 4B. DATA RECEIVE/READ
FIGURE 4. H17190 SERIAL PORT TIMING

Programming the HI7190 with the 8X51

The serial port of the 8X51 and the HI7190 need to be configured after power-up or a hardware reset. The HI7190 Control Register must be set to comply with the 8X51 data format and a conversion rate must be set. The following program initializes the 8X51 serial port and HI7190. Data is read in a polled fashion instead of interrupt driven.

8X51Microcode Example

Power-up/Reset, Port initialization Set-Up Port 1 for reading status bits Routine, Set Mode 0, Baud Rate= Polled Data, (No interrupts)

SSRINIT: MOV SCON, #0000 0000B;

SETB 91H; Set P1.1 for CS (Chip Select)

Reconfigure the HI7190 for Ascending Byte direction, LSB First

Note: HI7190 expects MSB first format until

after this write is complete.

ADINIT: MOV SBUF, # 0010 0001B;

MOV SBUF, # 0110 0000B;

Poll DRDY Signal for Data Ready when ready assert Chip Select (CS), write instruction byte and read 24 bits

of information

ADRUN: MOV R1, #003H;

MOV R0, START_ADDRESS;

MOV R2, #001H; MOV R3, DATA STREAM SIZE;

POLL_DRDY MOV A, P1;

ANL A,R2; JZ READ_DATA;

SJMP POLL DRDY;

READ_DATA CLR P1.1;

MOV SBUF, #0100 0000B;

DATA_LOOP MOV A,SBUF; MOV @R0, A;

INC R0; DEC R1;

JZ DATA_LOOP;

SETB P1.1; DEC R3; JZ FINISHED;

SJMP POLL_DRDY;

RET;

The initialization (SPINIT) configures the Serial Port in Mode 0 operation where the shift clock is generated by the 8X51 and the baud rate is set at $f_{\rm OSC}/12$. The baud rate should not exceed the HI7190's specification of 5Mbps. Port 1 bit 1 is the control bit Chip Select that enables the HI7190's serial port. The ADINIT module configures the HI7190 operating mode. After a power-up the HI7190's control register is initialized for offset binary data coding, and a conversion rate of 30Hz. The gain is set to 1, the byte sequencing on port accesses is descending (2..1..0) the MSB is the first bit shifted in serial transfer, the serial data out line is disabled, the burn-out current source is disabled. Also, after power-up, a self calibration is completed before the HI7190 begins actively converting.



The ADINIT module will change the byte sequencing to ascending where the least significant byte is sent first (0.. 1.. 2) to match the Intel little endian data structure. The shift order is also changed from the MSB first to the LSB first in the serial transfer. Gain = 1 and SDO disabled are maintained.

The ADRUN module initializes the byte count for data transfers into the R1 register while the starting address for the incoming data storage is set as well as the data buffer size. R2 is set with the mask value for the DRDY flag which can be read or Port 1 bit 0.

The POLL_DRDY module checks the status of the DRDY flag from the HI7190 A/D converter, upon detecting DRDY being low the READ_DATA module will be called.

The READ_DATA module will assert the \overline{CS} signal for the HI7190 serial port low and write the instruction byte to the A/D. Three bytes of data will be read from the A/D comprising the entire 24 bits from the conversion and the if the data buffer is full the routine will return to the main calling routine

Interfacing to the SPI Bus Protocol

The Serial Peripheral Interface (SPI Bus) is a serial bus using a 3-wire hardware interface. The three lines used to transfer data from one device to the other are the Serial Clock (SCK) line, the Master In Slave Out (MISO) data line and the Master Out Slave In (MOSI) data line. Data is shifted MSB first, and byte sequencing is in descending order (2.. 1 ..0). The clock is typically inactive low. Port D line 4 is the SCK. The shift clock is generated by the bus master which can be either a microcontroller or a peripheral. Data is routed either to PD2 (Master In Slave Out) or PD3 (Master Out Slave In) depending or software initialization. The Slave Select (SS) line determines if the 68HC11 microcontroller is a Master or Slave on the SPI Bus.

The Serial Peripheral Data I/O register in the microcontroller initiates transmission/reception of a byte. The SPI port on the microcontroller is configured using the Serial Peripheral Control Register. Many devices contain SPI ports such as the 6805, and 6802 but this discussion will center on the 68HC11. When connecting an HI7190 Sigma-Delta A/D converter to the SPI Port of the 68HC11 the user has many configuration options available. The serial clock generation can be generated by the HI7190 using Self Clocking mode or by the 68HC11. In Figure 5 the HI7190 is configured as the clock master for the SPI port. This is accomplished by pulling the MODE line on the HI7190 high ('1') and grounding the Slave Select (SS) pin of the microcontroller. Conversely, if the microcontroller was to be the clock master then the SS line would be tied high and the MODE pin grounded. The DRDY line of the A/D converter can be monitored via an interrupt scheme or by using simple polling. The programming example uses a polled status scheme.

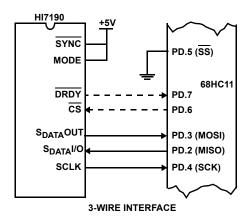


FIGURE 5. HI7190 INTERFACE TO 68HC1

Programming the HI7190 with the 68HC11

The serial ports of the HI7190 A/D converter and the 68HC11 must be configured after power-up or a hardware reset.

68HC11 Microcode Example

*This subroutine will configure the SPI port and the *HI7190 A/D converter. It will read a stream of data *and store it in memory

*Configuration of the SPI Control Register in no *interrupt, system enable, normal CMOS outputs,

*slave mode, SCK idle hi, clock phase hi, clock divder=2

*

SPINIT	CLRA		
	LDAA	#%x1xx xx	xxx Bit 6 Port D drives \overline{CS}
	STAA	PORTD	CS inactive
	LDAA	#\$4C	Init SP
	STAA	SPCR	Load SPI Control Reg
	LDAA	SPDR	Read to clear port

*Initialize the HI7190 Control Register, Two's

*Complement, Conversion Rate = 30Hz Conversion

*Mode Operation, Bipolar, **Gain = 1,** Descending

*Byte direction, MSB First, Serial Data Out Enabled.

••			
ADINIT	LDAA	#%x0xx xxx	x Bit 6 Port D drives CS
	STAA	PORTD	CS active
	LDAA	#\$C6	Instruction Byte
	STAA	SPDR	Load SPI Data Reg
WAIT	LDAA	SPSR	Check Port Status
	BPL	WAIT	Wait for port to Empty
	LDAA	#\$A8	Control Reg Byte 2
	STAA	SPDR	Load SPI Data Reg
WAIT1	LDAA	SPSR	Check Port Status
	BPL	WAIT1	Wait for port to Empty
	LDAA	#\$B1	Control Reg Byte 1
	STAA	SPDR	Load SPI Data Reg
WAIT2	LDAA	SPSR	Check Port Status
	BPL	WAIT2	Wait for port to Empty
	LDAA	#\$01	Control Reg Byte 0

SPDR

STAA

Load SPI Data Reg

WAIT3	LDAA BPL LDAA STAA	SPSR WAIT3 #%x1xx xxxx PORTD	Check Port Status Wait for port to Empty Bit 6 Port D drives CS CS inactive	
*This subroutine will collect data from the HI7190 *Sigma-Delta Converter, Poll DRDY Signal for Data *Ready when ready assert Chip Select (CS), write *instruction byte and read 24 bits of information *				
ADRUN DRDY	PSHX PSHY PSHA PSHB LDY LDX LDAA LDAB	STRT_ADD BUFF_SIZE PORTA #\$03		
RD_DATA	ANDA BNE LDAA STAA LDAA STAA	DRDY	80H for Port D MSB DRDY Cleared? Bit 6 Port D drives CS CS active Instruction Byte Load into HI7190	
WAIT4	LDAA BPL	SPSR WAIT4	Check Port Status Wait for port to Empty	
D_LOOP	LDAA BPL LDAA STAA INY DECB CMPB BNE CPY BNE RTS	SPSR D_LOOP SPDR STRT_ADD #\$00 RD_DATA X DRDY	Check Port Status Wait for new input data Read Data Byte Store in Memory Bump Address Pointer Decrement Byte Counter Test Byte Counter Read another byte Compare Buffer pointer to buffer size Poll for more data Done Return from subroutine	

Conclusion

This application note has described two typical application circuits with microcode segment examples.

The first circuit is designed with the 8X51 microcontroller(s) in a configuration such that the 8X51 is the clock master in a two line interface and data transfers are LSB to MSB format.

The second circuit is designed with the 68HCxx microcontroller(s) in a configuration such that the Hi7190 is the clock master in a three line interface and data transfers are MSB to LSB format.



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